

M16C/Tiny Series

Operation of Timer A (Timer Mode, Gate Function)

1. Abstract

In timer mode, choose functions from those listed in Table 1. Operations of the checked items are described below.

Table 1. Chosed Functions

Item	Set-up	
Count source		f1 or f2
	Yes	f8
		f32
		fC32
Pulse output function	Yes	No pulses output
		Pulses output
Gate function		No gate function
		Performs count only for the period in which the TAI _{IN} pin is at "L" level
	Yes	Performs count only for the period in which the TAI _{IN} pin is at "H" level

2. Introduction

The explanation of this issue is applied to the following condition:

Applicable MCU: M16C/26, M16C/26A, M16C/28, M16C/29 Group

This program can also be used when operating other microcomputers within the M16C family, provided they have the same SFR (Special Function Registers) as the M16C/26, M16C/26A, M16C/28, M16C/29 microcomputers. However, some functions may have been modified.

Refer to the User's Manual for details. Use functions covered in this Application Note only after careful evaluation.

3. Operation of Timer A

- (1) When the count start flag is set to "1" and the TAI_{IN} pin inputs at "H" level, the counter performs a down count on the count source.
- (2) When the TAI_{IN} pin inputs at "L" level, the counter holds its value and stops.
- (3) If an underflow occurs, the content of the reload register is reloaded, and the count continues. At this time, the timer Ai interrupt request bit goes to "1".
- (4) Setting the count start flag to "0" causes the counter to hold its value and to stop.

Complement: Make the pulse width of the signal input to the TAI_{IN} pin not less than two cycles of the count source.

Figure 1 shows the operation timing of timer mode, gate function selected.

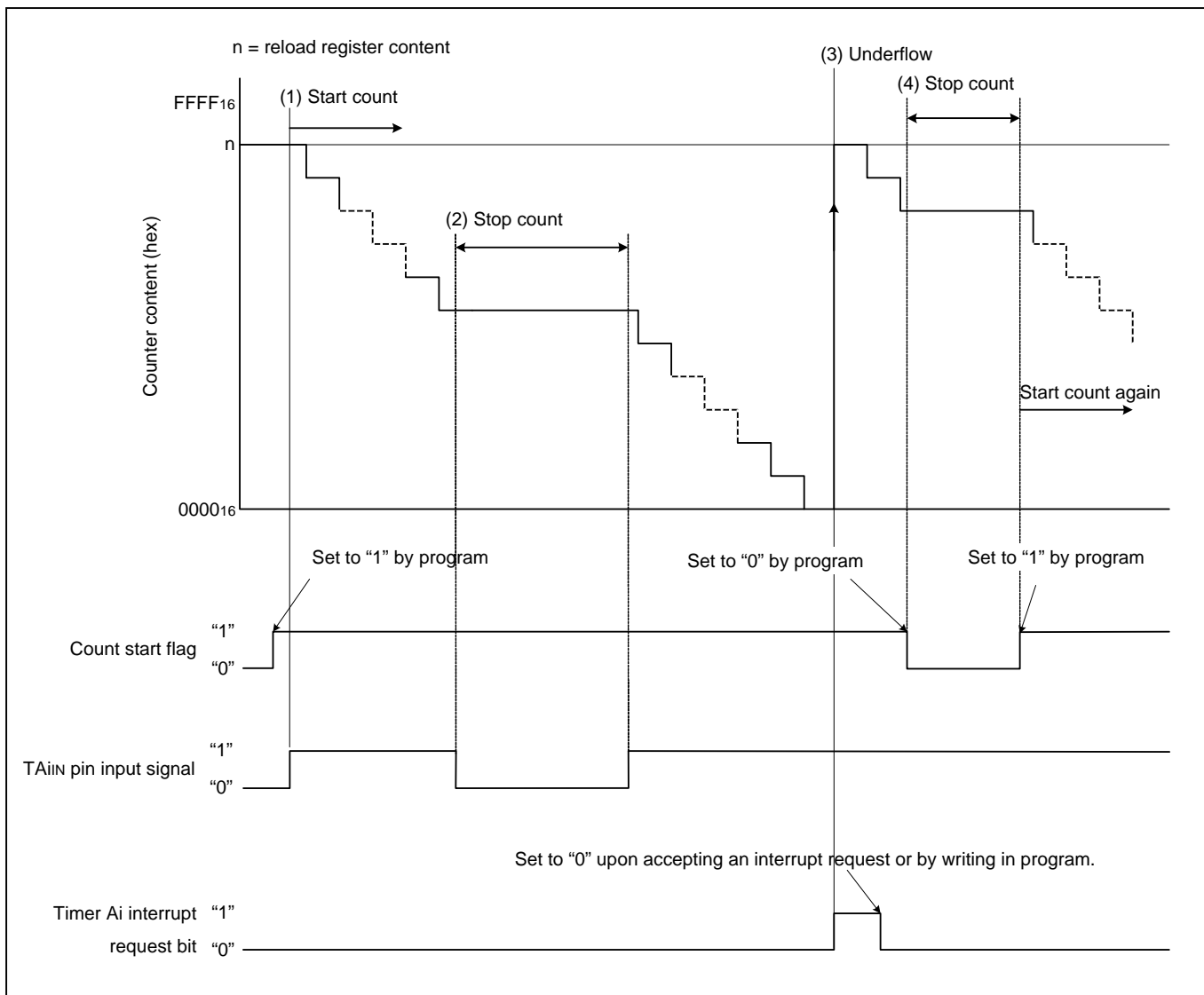
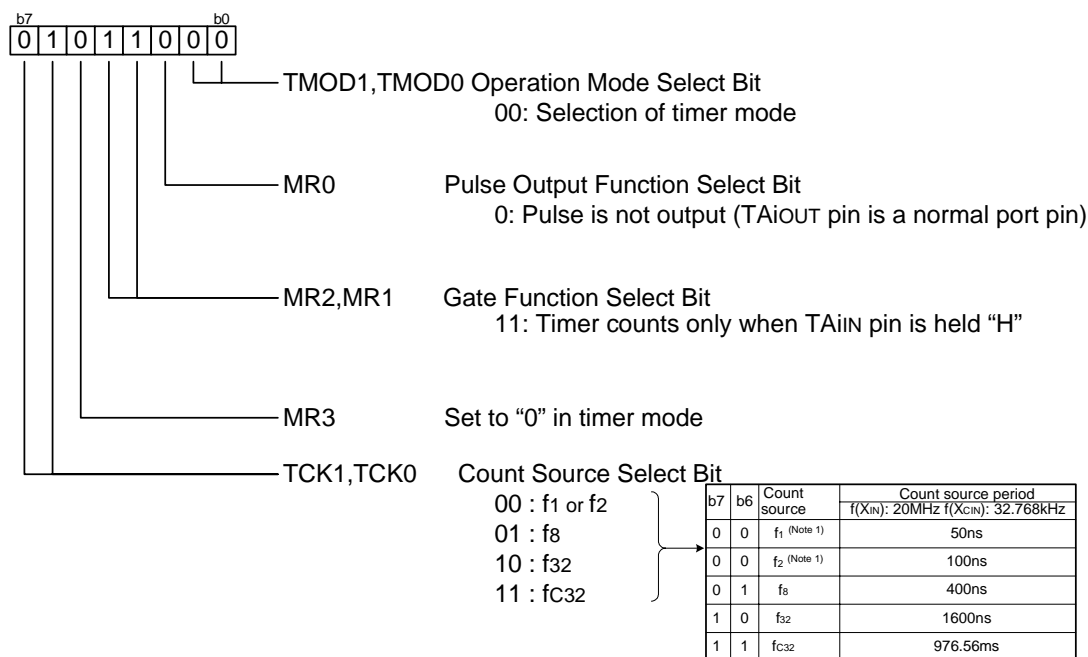


Figure 1. Operation Timing of Timer Mode, Gate Function Selected

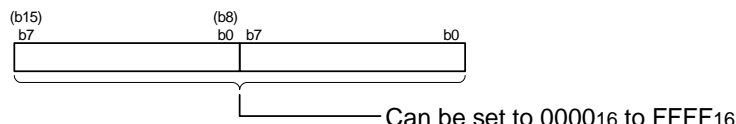
3.1 Register Setting

To enable the operation defined in “Section 3. Operation of timer A”, the following register settings must be taken place step by step. For detail configuration of each register, please refer to M16C/26 Group hardware manual, M16C/26A Group hardware manual, M16C/28 Group hardware manual, M16C/29 Group hardware manual.

(1) Setting timer Ai mode register (i=0 to 4)

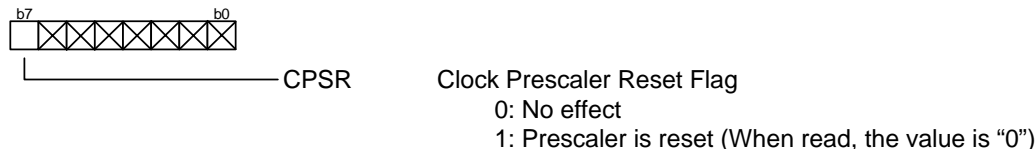


(2) Setting timer Ai register (i=0 to 4)

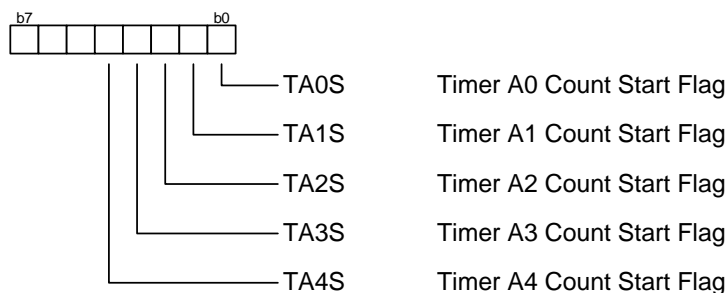


(3) Setting clock prescaler reset flag

(This function is effective when f_{C32} is selected as the count source. Reset the prescaler for generating f_{C32} by dividing the X_{CIN} by 32.)



(4) Setting count start flag



4. Sample Program

```

/*****
 *
 *   FILE NAME :
 *   CPU       : M16C/Tiny series
 *   Function  : Operation of Timer A
 *               (Timer Mode, Gate function)
 *   Version   : 1.00
 *
 *   Copyright (C)2004, Renesas Technology Corp.
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 *
 *****/
/*****
 *   include file
 *****/
#include "sfr28.h"

/*****
 *   main
 *****/
void main(void) {

    pd7_3 = 0; /* Set the corresponding port direction register to "0" */

    talmr = 0x58; /* Selection of timer mode
                  Pulse output function select bit (0:Pulse is not output)
                  Gate function select bit (11:Timer counts only when TAIIN pin is heold "H" )
                  Count source (01:f8) */

    tal = 2500-1; /* Setting counter value (1msec @20MHz, f8) */

    cpsrf = 0; /* Setting clock prescaler reset flag (0:No effect) */

    tals = 1; /* TimerA1 count start */

    while (1) {
    }
}

```

5. Reference

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Hardware Manual

M16C/26, M16C/26A, M16C/28, M16C/29 Group Hardware Manual

(Use the latest version on the home page: <http://www.renesas.com>)

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